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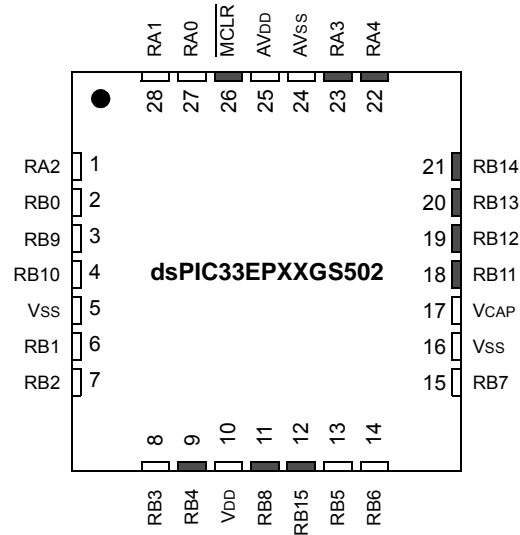
#### Details

Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	70 MIPS
Connectivity	I <sup>2</sup> C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	35
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 19x12b; D/A 1x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-TQFP Exposed Pad
Supplier Device Package	48-TQFP-EP (7x7)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep32gs505-i-pt">https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep32gs505-i-pt</a>

# dsPIC33EPXXGS50X FAMILY

## Pin Diagrams (Continued)

28-Pin QFN-S, UQFN



Pin	Pin Function	Pin	Pin Function
1	AN2/PGA1P3/PGA2P2/CMP1C/CMP2A/RA2	15	PGEC1/AN21/SDA1/ <b>RP39</b> /RB7
2	AN3/PGA2P3/CMP1D/CMP2B/ <b>RP32</b> /RB0	16	Vss
3	AN4/CMP2C/CMP3A/ISRC4/ <b>RP41</b> /RB9	17	VCAP
4	AN5/CMP2D/CMP3B/ISRC3/ <b>RP42</b> /RB10	18	TMS/PWM3H/ <b>RP43</b> /RB11
5	Vss	19	TCK/PWM3L/ <b>RP44</b> /RB12
6	OSC1/CLKI/AN6/CMP3C/CMP4A/ISRC2/ <b>RP33</b> /RB1	20	PWM2H/ <b>RP45</b> /RB13
7	OSC2/CLKO/AN7/PGA1N2/CMP3D/CMP4B/ <b>RP34</b> /RB2	21	PWM2L/ <b>RP46</b> /RB14
8	PGED2/AN18/DACOUT1/INT0/ <b>RP35</b> /RB3	22	PWM1H/RA4
9	PGEC2/ADTRG31/EXTREF1/RP36/RB4	23	PWM1L/RA3
10	VDD	24	AVss
11	PGED3/SDA2/FLT31/RP40/RB8	25	AVDD
12	PGEC3/SCL2/ <b>RP47</b> /RB15	26	<b>MCLR</b>
13	TDO/AN19/PGA2N2/ <b>RP37</b> /RB5	27	AN0/PGA1P1/CMP1A/RA0
14	PGED1/TDI/AN20/SCL1/ <b>RP38</b> /RB6	28	AN1/PGA1P2/PGA2P1/CMP1B/RA1

**Legend:** Shaded pins are up to 5 VDC tolerant.

**RPn** represents remappable peripheral functions. See Table 10-1 and Table 10-2 for the complete list of remappable sources.

## 2.5 ICSP Pins

The PGECx and PGEDx pins are used for ICSP and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of Ohms, not to exceed 100 Ohms.

Pull-up resistors, series diodes and capacitors on the PGECx and PGEDx pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits and pin Voltage Input High (V<sub>IH</sub>) and Voltage Input Low (V<sub>IL</sub>) requirements.

Ensure that the “Communication Channel Select” (i.e., PGECx/PGEDx pins) programmed into the device matches the physical connections for the ICSP to MPLAB® PICKit™ 3, MPLAB ICD 3, or MPLAB REAL ICE™.

For more information on MPLAB ICD 2, MPLAB ICD 3 and REAL ICE connection requirements, refer to the following documents that are available on the Microchip web site.

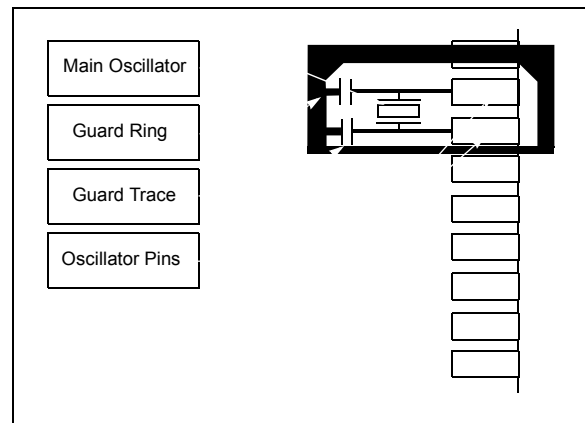
- “Using MPLAB® ICD 3” (poster) DS51765
- “Multi-Tool Design Advisory” DS51764
- “MPLAB® REAL ICE™ In-Circuit Emulator User’s Guide” DS51616
- “Using MPLAB® REAL ICE™ In-Circuit Emulator” (poster) DS51749

## 2.6 External Oscillator Pins

Many DSCs have options for at least two oscillators: a high-frequency primary oscillator and a low-frequency secondary oscillator. For details, see **Section 8.0 “Oscillator Configuration”** for details.

The oscillator circuit should be placed on the same side of the board as the device. Also, place the oscillator circuit close to the respective oscillator pins, not exceeding one-half inch (12 mm) distance between them. The load capacitors should be placed next to the oscillator itself, on the same side of the board. Use a grounded copper pour around the oscillator circuit to isolate them from surrounding circuits. The grounded copper pour should be routed directly to the MCU ground. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed. A suggested layout is shown in Figure 2-3.

**FIGURE 2-3: SUGGESTED PLACEMENT OF THE OSCILLATOR CIRCUIT**



## 4.3 Data Address Space

The dsPIC33EPXXGS50X family CPU has a separate 16-bit wide data memory space. The Data Space is accessed using separate Address Generation Units (AGUs) for read and write operations. The data memory maps are shown in Figure 4-6 through Figure 4-8.

All Effective Addresses (EAs) in the data memory space are 16 bits wide and point to bytes within the Data Space. This arrangement gives a base Data Space address range of 64 Kbytes or 32K words.

The lower half of the data memory space (i.e., when  $EA<15> = 0$ ) is used for implemented memory addresses, while the upper half ( $EA<15> = 1$ ) is reserved for the Program Space Visibility (PSV).

dsPIC33EPXXGS50X family devices implement up to 12 Kbytes of data memory. If an EA points to a location outside of this area, an all-zero word or byte is returned.

### 4.3.1 DATA SPACE WIDTH

The data memory space is organized in byte-addressable, 16-bit wide blocks. Data is aligned in data memory and registers as 16-bit words, but all Data Space EAs resolve to bytes. The Least Significant Bytes (LSBs) of each word have even addresses, while the Most Significant Bytes (MSBs) have odd addresses.

### 4.3.2 DATA MEMORY ORGANIZATION AND ALIGNMENT

To maintain backward compatibility with PIC® MCU devices and improve Data Space memory usage efficiency, the dsPIC33EPXXGS50X family instruction set supports both word and byte operations. As a consequence of byte accessibility, all Effective Address calculations are internally scaled to step through word-aligned memory. For example, the core recognizes that Post-Modified Register Indirect Addressing mode [Ws++] results in a value of Ws + 1 for byte operations and Ws + 2 for word operations.

A data byte read, reads the complete word that contains the byte, using the LSB of any EA to determine which byte to select. The selected byte is placed onto the LSB of the data path. That is, data memory and registers are organized as two parallel, byte-wide entities with shared (word) address decode, but separate write lines. Data byte writes only write to the corresponding side of the array or register that matches the byte address.

All word accesses must be aligned to an even address. Misaligned word data fetches are not supported, so care must be taken when mixing byte and word operations, or translating from 8-bit MCU code. If a misaligned read or write is attempted, an address error trap is generated. If the error occurred on a read, the instruction underway is completed. If the error occurred on a write, the instruction is executed but the write does not occur. In either case, a trap is then executed, allowing the system and/or user application to examine the machine state prior to execution of the address Fault.

All byte loads into any W register are loaded into the LSB; the MSB is not modified.

A Sign-Extend (SE) instruction is provided to allow user applications to translate 8-bit signed data to 16-bit signed values. Alternatively, for 16-bit unsigned data, user applications can clear the MSB of any W register by executing a Zero-Extend (ZE) instruction on the appropriate address.

### 4.3.3 SFR SPACE

The first 4 Kbytes of the Near Data Space, from 0x0000 to 0x0FFF, is primarily occupied by Special Function Registers (SFRs). These are used by the dsPIC33EPXXGS50X family core and peripheral modules for controlling the operation of the device.

SFRs are distributed among the modules that they control, and are generally grouped together by module. Much of the SFR space contains unused addresses; these are read as '0'.

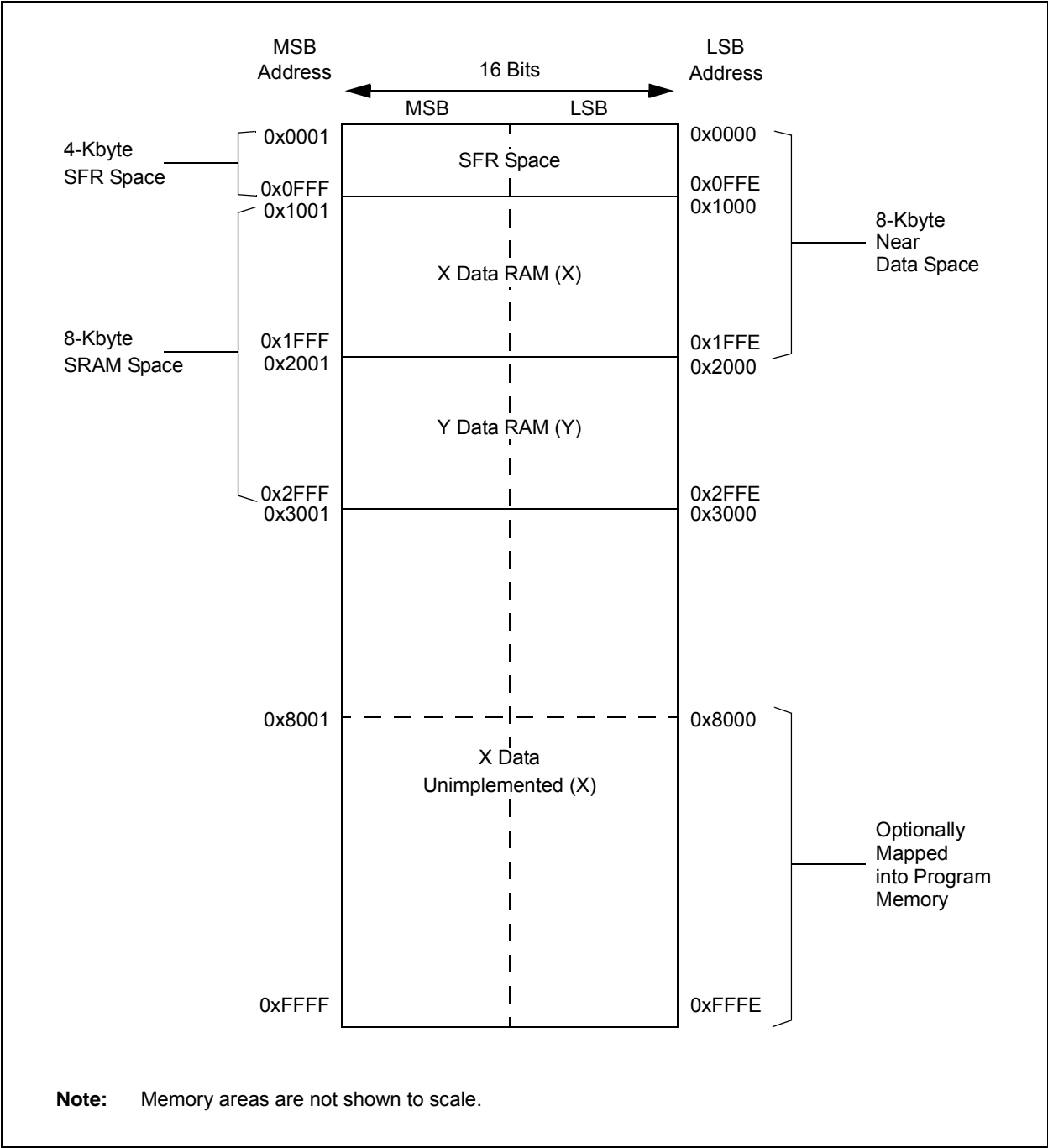
<b>Note:</b> The actual set of peripheral features and interrupts varies by the device. Refer to the corresponding device tables and pinout diagrams for device-specific information.
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### 4.3.4 NEAR DATA SPACE

The 8-Kbyte area, between 0x0000 and 0x1FFF, is referred to as the Near Data Space. Locations in this space are directly addressable through a 13-bit absolute address field within all memory direct instructions. Additionally, the whole Data Space is addressable using MOV instructions, which support Memory Direct Addressing mode with a 16-bit address field, or by using Indirect Addressing mode using a Working register as an Address Pointer.

# dsPIC33EPXXGS50X FAMILY

FIGURE 4-8: DATA MEMORY MAP FOR dsPIC33EP64GS50X DEVICES



**TABLE 4-9: PWM GENERATOR 2 REGISTER MAP**

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PWMCON2	0C40	FLTSTAT	CLSTAT	TRGSTAT	FLTEN	CLIEN	TRGIEN	ITB	MDCS	DTC1	DTC0	—	—	MTBS	CAM	XPRES	IUE	0000
IOCON2	0C42	PENH	PENL	POLH	POLL	PMOD1	PMOD0	OVRENH	OVRENL	OVRDAT1	OVRDAT0	FLTDAT1	FLTDAT0	CLDAT1	CLDAT0	SWAP	OSYNC	C000
FCLCON2	0C44	IFLTMOD	CLSRC4	CLSRC3	CLSRC2	CLSRC1	CLSRC0	CLPOL	CLMOD	FLTSRC4	FLTSRC3	FLTSRC2	FLTSRC1	FLTSRC0	FLTPOL	FLTMOD1	FLTMOD0	00F8
PDC2	0C46	PWM2 Generator Duty Cycle Register (PDC2<15:0>)																0000
PHASE2	0C48	PWM2 Primary Phase-Shift or Independent Time Base Period Register (PHASE2<15:0>)																0000
DTR2	0C4A	—	—	PWM2 Dead-Time Register (DTR2<13:0>)														0000
ALTDTR2	0C4C	—	—	PWM2 Alternate Dead-Time Register (ALTDTR2<13:0>)														0000
SDC2	0C4E	PWM2 Secondary Duty Cycle Register (SDC2<15:0>)																0000
SPHASE2	0C50	PWM2 Secondary Phase-Shift Register (SPHASE2<15:0>)																0000
TRIG2	0C52	PWM2 Primary Trigger Compare Value Register (TRGCMPCMP<12:0>)												—	—	—	0000	
TRGCON2	0C54	TRGDIV3	TRGDIV2	TRGDIV1	TRGDIV0	—	—	—	—	DTM	—	TRGSTRT5	TRGSTRT4	TRGSTRT3	TRGSTRT2	TRGSTRT1	TRGSTRT0	0000
STRIG2	0C56	PWM2 Secondary Trigger Compare Value Register (STRGCMPCMP<12:0>)												—	—	—	0000	
PWMCAP2	0C58	PWM2 Primary Time Base Capture Register (PWMCAP<12:0>)												—	—	—	0000	
LEBCON2	0C5A	PHR	PHF	PLR	PLF	FLTLEBEN	CLLEBEN	—	—	—	—	BCH	BCL	BPHH	BPHL	BPLH	BPLL	0000
LEBDLY2	0C5C	—	—	—	—	PWM2 Leading-Edge Blanking Delay Register (LEB<8:0>)									—	—	—	0000
AUXCON2	0C5E	HRPDIS	HRDDIS	—	—	BLANKSEL3	BLANKSEL2	BLANKSEL1	BLANKSEL0	—	—	CHOPSEL3	CHOPSEL2	CHOPSEL1	CHOPSEL0	CHOPHEN	CHOPLEN	0000

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-10: PWM GENERATOR 3 REGISTER MAP**

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PWMCON3	0C60	FLTSTAT	CLSTAT	TRGSTAT	FLTEN	CLIEN	TRGIEN	ITB	MDCS	DTC1	DTC0	—	—	MTBS	CAM	XPRES	IUE	0000
IOCON3	0C62	PENH	PENL	POLH	POLL	PMOD1	PMOD0	OVRENH	OVRENL	OVRDAT1	OVRDAT0	FLTDAT1	FLTDAT0	CLDAT1	CLDAT0	SWAP	OSYNC	C000
FCLCON3	0C64	IFLTMOD	CLSRC4	CLSRC3	CLSRC2	CLSRC1	CLSRC0	CLPOL	CLMOD	FLTSRC4	FLTSRC3	FLTSRC2	FLTSRC1	FLTSRC0	FLTPOL	FLTMOD1	FLTMOD0	00F8
PDC3	0C66	PWM3 Generator Duty Cycle Register (PDC3<15:0>)																0000
PHASE3	0C68	PWM3 Primary Phase-Shift or Independent Time Base Period Register (PHASE3<15:0>)																0000
DTR3	0C6A	—	—	PWM3 Dead-Time Register (DTR3<13:0>)														0000
ALTDTR3	0C6C	—	—	PWM3 Alternate Dead-Time Register (ALTDTR3<13:0>)														0000
SDC3	0C6E	PWM3 Secondary Duty Cycle Register (SDC3<15:0>)																0000
SPHASE3	0C70	PWM3 Secondary Phase-Shift Register (SPHASE3<15:0>)																0000
TRIG3	0C72	PWM3 Primary Trigger Compare Value Register (TRGCMPCMP<12:0>)												—	—	—	—	0000
TRGCON3	0C74	TRGDIV3	TRGDIV2	TRGDIV1	TRGDIV0	—	—	—	—	DTM	—	TRGSTRT5	TRGSTRT4	TRGSTRT3	TRGSTRT2	TRGSTRT1	TRGSTRT0	0000
STRIG3	0C76	PWM3 Secondary Trigger Compare Value Register (STRGCMPCMP<12:0>)												—	—	—	—	0000
PWMCAP3	0C78	PWM3 Primary Time Base Capture Register (PWMCAP<12:0>)												—	—	—	—	0000
LEBCON3	0C7A	PHR	PHF	PLR	PLF	FLTLEBEN	CLLEBEN	—	—	—	—	BCH	BCL	BPHH	BPHL	BPLH	BPLL	0000
LEBDLY3	0C7C	—	—	—	—	PWM3 Leading-Edge Blanking Delay Register (LEB<8:0>)									—	—	—	0000
AUXCON3	0C7E	HRPDIS	HRDDIS	—	—	BLANKSEL3	BLANKSEL2	BLANKSEL1	BLANKSEL0	—	—	CHOPSEL3	CHOPSEL2	CHOPSEL1	CHOPSEL0	CHOPHEN	CHOPLEN	0000

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

# dsPIC33EPXXGS50X FAMILY

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## REGISTER 7-3: INTCON1: INTERRUPT CONTROL REGISTER 1 (CONTINUED)

- bit 2      **STKERR:** Stack Error Trap Status bit  
            1 = Stack error trap has occurred  
            0 = Stack error trap has not occurred
- bit 1      **OSCFAIL:** Oscillator Failure Trap Status bit  
            1 = Oscillator failure trap has occurred  
            0 = Oscillator failure trap has not occurred
- bit 0      **Unimplemented:** Read as '0'

# dsPIC33EPXXGS50X FAMILY

## REGISTER 8-2: CLKDIV: CLOCK DIVISOR REGISTER (CONTINUED)

bit 4-0 **PLLPRE<4:0>**: PLL Phase Detector Input Divider Select bits (also denoted as 'N1', PLL prescaler)

11111 = Input divided by 33

•

•

•

00001 = Input divided by 3

00000 = Input divided by 2 (default)

- Note 1:** The DOZE<2:0> bits can only be written to when the DOZEN bit is clear. If DOZEN = 1, any writes to DOZE<2:0> are ignored.
- 2:** This bit is cleared when the ROI bit is set and an interrupt occurs.
- 3:** The DOZEN bit cannot be set if DOZE<2:0> = 000. If DOZE<2:0> = 000, any attempt by user software to set the DOZEN bit is ignored.

## REGISTER 8-3: PLLFBD: PLL FEEDBACK DIVISOR REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	—	PLLDIV8
bit 15							bit 8

R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0
PLLDIV<7:0>							
bit 7							bit 0

### Legend:

R = Readable bit      W = Writable bit      U = Unimplemented bit, read as '0'

-n = Value at POR      '1' = Bit is set      '0' = Bit is cleared      x = Bit is unknown

bit 15-9 **Unimplemented:** Read as '0'

bit 8-0 **PLLDIV<8:0>**: PLL Feedback Divisor bits (also denoted as 'M', PLL multiplier)

111111111 = 513

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•

•

000110000 = 50 (default)

•

•

•

000000010 = 4

000000001 = 3

000000000 = 2



# dsPIC33EPXXGS50X FAMILY

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## 9.2.1 SLEEP MODE

The following occurs in Sleep mode:

- The system clock source is shut down. If an on-chip oscillator is used, it is turned off.
- The device current consumption is reduced to a minimum, provided that no I/O pin is sourcing current.
- The Fail-Safe Clock Monitor does not operate, since the system clock source is disabled.
- The LPRC clock continues to run in Sleep mode if the WDT is enabled.
- The WDT, if enabled, is automatically cleared prior to entering Sleep mode.
- Some device features or peripherals can continue to operate. This includes items such as the Input Change Notification on the I/O ports or peripherals that use an external clock input.
- Any peripheral that requires the system clock source for its operation is disabled.

The device wakes up from Sleep mode on any of the these events:

- Any interrupt source that is individually enabled
- Any form of device Reset
- A WDT time-out

On wake-up from Sleep mode, the processor restarts with the same clock source that was active when Sleep mode was entered.

For optimal power savings, the internal regulator and the Flash regulator can be configured to go into stand-by when Sleep mode is entered by clearing the VREGS (RCON<8>) and VREGSF (RCON<11>) bits (default configuration).

If the application requires a faster wake-up time, and can accept higher current requirements, the VREGS (RCON<8>) and VREGSF (RCON<11>) bits can be set to keep the internal regulator and the Flash regulator active during Sleep mode.

## 9.2.2 IDLE MODE

The following occurs in Idle mode:

- The CPU stops executing instructions.
- The WDT is automatically cleared.
- The system clock source remains active. By default, all peripheral modules continue to operate normally from the system clock source, but can also be selectively disabled (see **Section 9.4 “Peripheral Module Disable”**).
- If the WDT or FSCM is enabled, the LPRC also remains active.

The device wakes from Idle mode on any of these events:

- Any interrupt that is individually enabled
- Any device Reset
- A WDT time-out

On wake-up from Idle mode, the clock is reapplied to the CPU and instruction execution will begin (2-4 clock cycles later), starting with the instruction following the `PWRSV` instruction or the first instruction in the ISR.

All peripherals also have the option to discontinue operation when Idle mode is entered to allow for increased power savings. This option is selectable in the control register of each peripheral (for example, the `TSIDL` bit in the Timer1 Control register (T1CON<13>)).

## 9.2.3 INTERRUPTS COINCIDENT WITH POWER SAVE INSTRUCTIONS

Any interrupt that coincides with the execution of a `PWRSV` instruction is held off until entry into Sleep or Idle mode has completed. The device then wakes up from Sleep or Idle mode.

# dsPIC33EPXXGS50X FAMILY

## 10.0 I/O PORTS

**Note 1:** This data sheet summarizes the features of the dsPIC33EPXXGS50X family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to “I/O Ports” (DS70000598) in the “dsPIC33/PIC24 Family Reference Manual”, which is available from the Microchip web site ([www.microchip.com](http://www.microchip.com)).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

Many of the device pins are shared among the peripherals and the Parallel I/O ports. All I/O input ports feature Schmitt Trigger inputs for improved noise immunity.

### 10.1 Parallel I/O (PIO) Ports

Generally, a Parallel I/O port that shares a pin with a peripheral is subservient to the peripheral. The peripheral's output buffer data and control signals are provided to a pair of multiplexers. The multiplexers select whether the peripheral or the associated port has ownership of the output data and control signals of

the I/O pin. The logic also prevents “loop through”, in which a port's digital output can drive the input of a peripheral that shares the same pin. Figure 10-1 illustrates how ports are shared with other peripherals and the associated I/O pin to which they are connected.

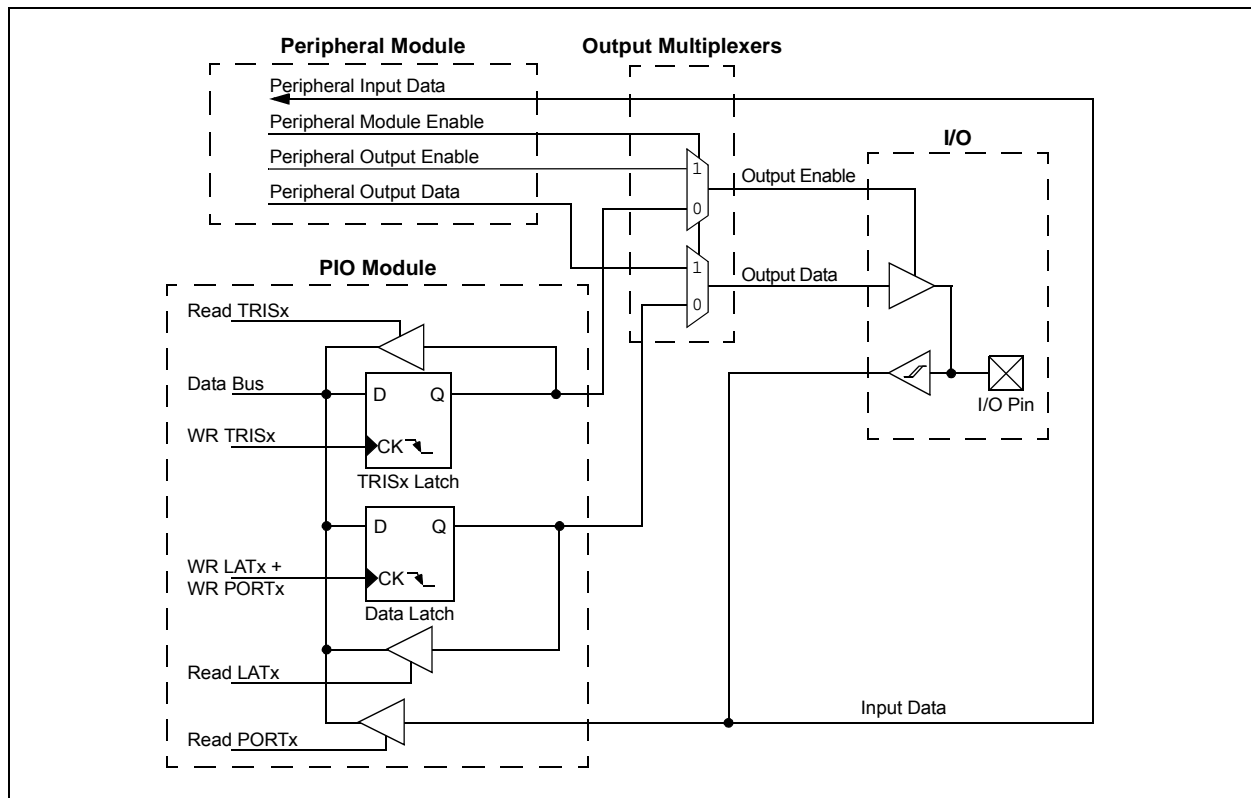
When a peripheral is enabled and the peripheral is actively driving an associated pin, the use of the pin as a general purpose output pin is disabled. The I/O pin can be read, but the output driver for the parallel port bit is disabled. If a peripheral is enabled, but the peripheral is not actively driving a pin, that pin can be driven by a port.

All port pins have eight registers directly associated with their operation as digital I/Os. The Data Direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is a '1', then the pin is an input. All port pins are defined as inputs after a Reset. Reads from the latch (LATx), read the latch. Writes to the latch, write the latch. Reads from the port (PORTx), read the port pins, while writes to the port pins, write the latch.

Any bit and its associated data and control registers that are not valid for a particular device are disabled. This means the corresponding LATx and TRISx registers, and the port pin are read as zeros.

When a pin is shared with another peripheral or function that is defined as an input only, it is nevertheless regarded as a dedicated port because there is no other competing source of outputs.

**FIGURE 10-1: BLOCK DIAGRAM OF A TYPICAL SHARED PORT STRUCTURE**



# dsPIC33EPXXGS50X FAMILY

## REGISTER 10-17: RPINR38: PERIPHERAL PIN SELECT INPUT REGISTER 38

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SYNCl2R7	SYNCl2R6	SYNCl2R5	SYNCl2R4	SYNCl2R3	SYNCl2R2	SYNCl2R1	SYNCl2R0
bit 7							bit 0

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-8

**Unimplemented:** Read as '0'

bit 7-0

**SYNCl2R<7:0>:** Assign PWM Synchronization Input 2 to the Corresponding RPn Pin bits

10110101 = Input tied to RP181

10110100 = Input tied to RP180

•

•

•

00000001 = Input tied to RP1

00000000 = Input tied to Vss

## 12.0 TIMER2/3 AND TIMER4/5

**Note 1:** This data sheet summarizes the features of the dsPIC33EPXXGS50X family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to “**Timers**” (DS70362) in the “*dsPIC33/PIC24 Family Reference Manual*”, which is available from the Microchip web site ([www.microchip.com](http://www.microchip.com)).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The Timer2/3 and Timer4/5 modules are 32-bit timers, which can also be configured as four independent 16-bit timers with selectable operating modes.

As 32-bit timers, Timer2/3 and Timer4/5 operate in three modes:

- Two Independent 16-Bit Timers (e.g., Timer2 and Timer3) with All 16-Bit Operating modes (except Asynchronous Counter mode)
- Single 32-Bit Timer
- Single 32-Bit Synchronous Counter

They also support these features:

- Timer Gate Operation
- Selectable Prescaler Settings
- Timer Operation during Idle and Sleep modes
- Interrupt on a 32-Bit Period Register Match
- Time Base for Input Capture and Output Compare modules (Timer2 and Timer3 only)

Individually, all four of the 16-bit timers can function as synchronous timers or counters. They also offer the features listed previously, except for the event trigger; this is implemented only with Timer2/3. The operating modes and enabled features are determined by setting the appropriate bit(s) in the T2CON, T3CON, T4CON and T5CON registers. T2CON and T4CON are shown in generic form in Register 12-1. T3CON and T5CON are shown in Register 12-2.

For 32-bit timer/counter operation, Timer2 and Timer4 are the least significant word (lsw); Timer3 and Timer5 are the most significant word (msw) of the 32-bit timers.

**Note:** For 32-bit operation, T3CON and T5CON control bits are ignored. Only T2CON and T4CON control bits are used for setup and control. Timer2 and Timer4 clock and gate inputs are utilized for the 32-bit timer modules, but an interrupt is generated with the Timer3 and Timer5 interrupt flags.

A block diagram for an example 32-bit timer pair (Timer2/3 and Timer4/5) is shown in Figure 12-2.

### 12.1 Timer Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page contains the latest updates and additional information.

#### 12.1.1 KEY RESOURCES

- “**Timers**” (DS70362) in the “*dsPIC33/PIC24 Family Reference Manual*”
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related “*dsPIC33/PIC24 Family Reference Manual*” Sections
- Development Tools

# dsPIC33EPXXGS50X FAMILY

**REGISTER 13-2: ICxCON2: INPUT CAPTURE x CONTROL REGISTER 2**

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	—	IC32
bit 15							bit 8

R/W-0	R/W-0, HS	U-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-1
ICTRIG <sup>(2)</sup>	TRIGSTAT <sup>(3)</sup>	—	SYNCSEL4 <sup>(4)</sup>	SYNCSEL3 <sup>(4)</sup>	SYNCSEL2 <sup>(4)</sup>	SYNCSEL1 <sup>(4)</sup>	SYNCSEL0 <sup>(4)</sup>
bit 7							bit 0

<b>Legend:</b>	HS = Hardware Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-9 **Unimplemented:** Read as '0'

bit 8 **IC32:** Input Capture x 32-Bit Timer Mode Select bit (Cascade mode)

- 1 = Odd ICx and even ICx form a single 32-bit input capture module<sup>(1)</sup>
- 0 = Cascade module operation is disabled

bit 7 **ICTRIG:** Input Capture x Trigger Operation Select bit<sup>(2)</sup>

- 1 = Input source is used to trigger the input capture timer (Trigger mode)
- 0 = Input source is used to synchronize the input capture timer to a timer of another module (Synchronization mode)

bit 6 **TRIGSTAT:** Timer Trigger Status bit<sup>(3)</sup>

- 1 = ICxTMR has been triggered and is running
- 0 = ICxTMR has not been triggered and is being held clear

bit 5 **Unimplemented:** Read as '0'

- Note 1:** The IC32 bit in both the odd and even ICx must be set to enable Cascade mode.
- 2:** The input source is selected by the SYNCSEL<4:0> bits of the ICxCON2 register.
- 3:** This bit is set by the selected input source (selected by SYNCSEL<4:0> bits); it can be read, set and cleared in software.
- 4:** Do not use the ICx module as its own sync or trigger source.
- 5:** This option should only be selected as a trigger source and not as a synchronization source.

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## REGISTER 15-22: FCLCONx: PWMx FAULT CURRENT-LIMIT CONTROL REGISTER (x = 1 to 5) (CONTINUED)

- bit 7-3 **FLTSRC<4:0>**: Fault Control Signal Source Select for PWMx Generator bits
- 11111 = Fault 31 (Default)
  - 10001 = Reserved
  - 10000 = Analog Comparator 4
  - 01111 = Analog Comparator 3
  - 01110 = Analog Comparator 2
  - 01101 = Analog Comparator 1
  - 01100 = Fault 12
  - 01011 = Fault 11
  - 01010 = Fault 10
  - 01001 = Fault 9
  - 01000 = Fault 8
  - 00111 = Fault 7
  - 00110 = Fault 6
  - 00101 = Fault 5
  - 00100 = Fault 4
  - 00011 = Fault 3
  - 00010 = Fault 2
  - 00001 = Fault 1
  - 00000 = Reserved
- bit 2 **FLTPOL**: Fault Polarity for PWMx Generator bit<sup>(1)</sup>
- 1 = The selected Fault source is active-low
  - 0 = The selected Fault source is active-high
- bit 1-0 **FLTMOD<1:0>**: Fault Mode for PWMx Generator bits
- 11 = Fault input is disabled
  - 10 = Reserved
  - 01 = The selected Fault source forces the PWMxH, PWMxL pins to FLTDATx values (cycle)
  - 00 = The selected Fault source forces the PWMxH, PWMxL pins to FLTDATx values (latched condition)

**Note 1:** These bits should be changed only when PTEN = 0 (PTCON<15>).

## REGISTER 15-23: STRIGx: PWMx SECONDARY TRIGGER COMPARE VALUE REGISTER (x = 1 to 5)<sup>(1)</sup>

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
STRGCMP<12:5>							
bit 15				bit 8			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0
STRGCMP<4:0>					—	—	—
bit 7				bit 0			

### Legend:

R = Readable bit      W = Writable bit      U = Unimplemented bit, read as '0'  
 -n = Value at POR      '1' = Bit is set      '0' = Bit is cleared      x = Bit is unknown

- bit 15-3 **STRGCMP<12:0>**: Secondary Trigger Compare Value bits
- When the secondary PWMx functions in the local time base, this register contains the compare values that can trigger the ADC module.
- bit 2-0 **Unimplemented**: Read as '0'

**Note 1:** STRIGx cannot generate the PWM trigger interrupts.

# dsPIC33EPXXGS50X FAMILY

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## REGISTER 19-26: ADTRIGxL: ADC CHANNEL TRIGGER x SELECTION REGISTER LOW (x = 0 to 5) (CONTINUED)

bit 4-0      **TRGSRG(4x)<4:0>**: Trigger Source Selection for Corresponding Analog Inputs bits

11111 = ADTRG31  
11110 = Reserved  
11101 = Reserved  
11100 = PWM Generator 5 current-limit trigger  
11011 = PWM Generator 4 current-limit trigger  
11010 = PWM Generator 3 current-limit trigger  
11001 = PWM Generator 2 current-limit trigger  
11000 = PWM Generator 1 current-limit trigger  
10111 = Output Compare 2 trigger  
10110 = Output Compare 1 trigger  
10101 = Reserved  
10100 = Reserved  
10011 = PWM Generator 5 secondary trigger  
10010 = PWM Generator 4 secondary trigger  
10001 = PWM Generator 3 secondary trigger  
10000 = PWM Generator 2 secondary trigger  
01111 = PWM Generator 1 secondary trigger  
01110 = PWM secondary Special Event Trigger  
01101 = Timer2 period match  
01100 = Timer1 period match  
01011 = Reserved  
01010 = Reserved  
01001 = PWM Generator 5 primary trigger  
01000 = PWM Generator 4 primary trigger  
00111 = PWM Generator 3 primary trigger  
00110 = PWM Generator 2 primary trigger  
00101 = PWM Generator 1 primary trigger  
00100 = PWM Special Event Trigger  
00011 = Reserved  
00010 = Level software trigger  
00001 = Common software trigger  
00000 = No trigger is enabled

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## REGISTER 19-29: ADCAL0H: ADC CALIBRATION REGISTER 0 HIGH

R-0, HSC	U-0	U-0	U-0	r-0	R/W-0	R/W-0	R/W-0
CAL3RDY	—	—	—	—	CAL3DIFF	CAL3EN	CAL3RUN
bit 15						bit 8	

R-0, HSC	U-0	U-0	U-0	r-0	R/W-0	R/W-0	R/W-0
CAL2RDY	—	—	—	—	CAL2DIFF	CAL2EN	CAL2RUN
bit 7						bit 0	

<b>Legend:</b>	r = Reserved bit	U = Unimplemented bit, read as '0'
R = Readable bit	W = Writable bit	HSC = Hardware Settable/Clearable bit
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared
		x = Bit is unknown

- bit 15      **CAL3RDY:** Dedicated ADC Core 3 Calibration Status Flag bit  
1 = Dedicated ADC Core 3 calibration is finished  
0 = Dedicated ADC Core 3 calibration is in progress
- bit 14-12    **Unimplemented:** Read as '0'
- bit 11      **Reserved:** Must be written as '0'
- bit 10      **CAL3DIFF:** Dedicated ADC Core 3 Differential-Mode Calibration bit  
1 = Dedicated ADC Core 3 will be calibrated in Differential Input mode  
0 = Dedicated ADC Core 3 will be calibrated in Single-Ended Input mode
- bit 9        **CAL3EN:** Dedicated ADC Core 3 Calibration Enable bit  
1 = Dedicated ADC Core 3 calibration bits (CALxRDY, CALxDIFF and CALxRUN) can be accessed by software  
0 = Dedicated ADC Core 3 calibration bits are disabled
- bit 8        **CAL3RUN:** Dedicated ADC Core 3 Calibration Start bit  
1 = If this bit is set by software, the dedicated ADC Core 3 calibration cycle is started; this bit is automatically cleared by hardware  
0 = Software can start the next calibration cycle
- bit 7        **CAL2RDY:** Dedicated ADC Core 2 Calibration Status Flag bit  
1 = Dedicated ADC Core 2 calibration is finished  
0 = Dedicated ADC Core 2 calibration is in progress
- bit 6-4      **Unimplemented:** Read as '0'
- bit 3        **Reserved:** Must be written as '0'
- bit 2        **CAL2DIFF:** Dedicated ADC Core 2 Differential-Mode Calibration bit  
1 = Dedicated ADC Core 2 will be calibrated in Differential Input mode  
0 = Dedicated ADC Core 2 will be calibrated in Single-Ended Input mode
- bit 1        **CAL2EN:** Dedicated ADC Core 2 Calibration Enable bit  
1 = Dedicated ADC Core 2 calibration bits (CALxRDY, CALxDIFF and CALxRUN) can be accessed by software  
0 = Dedicated ADC Core 2 calibration bits are disabled
- bit 0        **CAL2RUN:** Dedicated ADC Core 2 Calibration Start bit  
1 = If this bit is set by software, the dedicated ADC Core 2 calibration cycle is started; this bit is automatically cleared by hardware  
0 = Software can start the next calibration cycle



# dsPIC33EPXXGS50X FAMILY

## REGISTER 19-32: ADCMPxENL: ADC DIGITAL COMPARATOR x CHANNEL ENABLE REGISTER LOW (x = 0 or 1)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CMPEN<15:8>							
bit 15				bit 8			

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CMPEN<7:0>							
bit 7				bit 0			

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-0

**CMPEN<15:0>:** Comparator Enable for Corresponding Input Channels bits

1 = Conversion result for corresponding channel is used by the comparator

0 = Conversion result for corresponding channel is not used by the comparator

## REGISTER 19-33: ADCMPxENH: ADC DIGITAL COMPARATOR x CHANNEL ENABLE REGISTER HIGH (x = 0 or 1)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
—	—	—	—	—	—	—	—
bit 15				bit 8			

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	CMPEN<21:16>					
bit 7				bit 0			

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-6

**Unimplemented:** Read as '0'

bit 5-0

**CMPEN<21:16>:** Comparator Enable for Corresponding Input Channels bits

1 = Conversion result for corresponding channel is used by the comparator

0 = Conversion result for corresponding channel is not used by the comparator

# dsPIC33EPXXGS50X FAMILY

## REGISTER 20-1: CMPxCON: COMPARATOR x CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CMPON	—	CMPSIDL	HYSSEL1	HYSSEL0	FLTREN	FCLKSEL	DACOE
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	HC-0, HS	R/W-0	R/W-0	R/W-0
INSEL1	INSEL0	EXTREF	HYSPOL	CMPSTAT	ALTINP	CMPPOL	RANGE
bit 7							bit 0

<b>Legend:</b>	HC = Hardware Clearable bit	HS = Hardware Settable bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared
		x = Bit is unknown

- bit 15 **CMPON:** Comparator Operating Mode bit  
 1 = Comparator module is enabled  
 0 = Comparator module is disabled (reduces power consumption)
- bit 14 **Unimplemented:** Read as '0'
- bit 13 **CMPSIDL:** Comparator Stop in Idle Mode bit  
 1 = Discontinues module operation when device enters Idle mode.  
 0 = Continues module operation in Idle mode  
 If a device has multiple comparators, any CMPSIDL bit set to '1' disables all comparators while in Idle mode.
- bit 12-11 **HYSSEL<1:0>:** Comparator Hysteresis Select bits  
 11 = 20 mV hysteresis  
 10 = 10 mV hysteresis  
 01 = 5 mV hysteresis  
 00 = No hysteresis is selected
- bit 10 **FLTREN:** Digital Filter Enable bit  
 1 = Digital filter is enabled  
 0 = Digital filter is disabled
- bit 9 **FCLKSEL:** Digital Filter and Pulse Stretcher Clock Select bit  
 1 = Digital filter and pulse stretcher operate with the PWM clock  
 0 = Digital filter and pulse stretcher operate with the system clock
- bit 8 **DACOE:** DACx Output Enable bit  
 1 = DACx analog voltage is connected to the DACOUTx pin<sup>(1)</sup>  
 0 = DACx analog voltage is not connected to the DACOUTx pin
- bit 7-6 **INSEL<1:0>:** Input Source Select for Comparator bits  
If ALTINP = 0, Select from Comparator Inputs:  
 11 = Selects CMPxD input pin  
 10 = Selects CMPxC input pin  
 01 = Selects CMPxB input pin  
 00 = Selects CMPxA input pin  
If ALTINP = 1, Select from Alternate Inputs:  
 11 = Reserved  
 10 = Reserved  
 01 = Selects PGA2 output  
 00 = Selects PGA1 output

**Note 1:** DACOUTx can be associated only with a single comparator at any given time. The software must ensure that multiple comparators do not enable the DACx output by setting their respective DACOE bit.

## 25.6 MPLAB X SIM Software Simulator

The MPLAB X SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB X SIM Software Simulator fully supports symbolic debugging using the MPLAB XC Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

## 25.7 MPLAB REAL ICE In-Circuit Emulator System

The MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs all 8, 16 and 32-bit MCU, and DSC devices with the easy-to-use, powerful graphical user interface of the MPLAB X IDE.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ-11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB X IDE. MPLAB REAL ICE offers significant advantages over competitive emulators including full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, logic probes, a ruggedized probe interface and long (up to three meters) interconnection cables.

## 25.8 MPLAB ICD 3 In-Circuit Debugger System

The MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost-effective, high-speed hardware debugger/programmer for Microchip Flash DSC and MCU devices. It debugs and programs PIC Flash microcontrollers and dsPIC DSCs with the powerful, yet easy-to-use graphical user interface of the MPLAB IDE.

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

## 25.9 PICkit 3 In-Circuit Debugger/Programmer

The MPLAB PICkit 3 allows debugging and programming of PIC and dsPIC Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB IDE. The MPLAB PICkit 3 is connected to the design engineer's PC using a full-speed USB interface and can be connected to the target via a Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the Reset line to implement in-circuit debugging and In-Circuit Serial Programming™ (ICSP™).

## 25.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages, and a modular, detachable socket assembly to support various package types. The ICSP cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices, and incorporates an MMC card for file storage and data applications.

# dsPIC33EPXXGS50X FAMILY

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NOTES:

# dsPIC33EPXXGS50X FAMILY

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

dsPIC 33 EP 64 GS5 04 T - I / PT XXX	
Microchip Trademark	_____
Architecture	_____
Flash Memory Family	_____
Program Memory Size (Kbyte)	_____
Product Group	_____
Pin Count	_____
Tape and Reel Flag (if applicable)	_____
Temperature Range	_____
Package	_____
Pattern	_____

<b>Architecture:</b>	33 = 16-Bit Digital Signal Controller
<b>Flash Memory Family:</b>	EP = Enhanced Performance
<b>Product Group:</b>	GS = SMPS Family
<b>Pin Count:</b>	02 = 28-pin 04 = 44-pin 05 = 48-pin 06 = 64-pin
<b>Temperature Range:</b>	I = -40°C to +85°C (Industrial) E = -40°C to +125°C (Extended)
<b>Package:</b>	2N = Ultra Thin Quad Flat, No Lead – (28-pin) 6x6 mm (UQFN) ML = Plastic Quad Flat, No Lead – (44-pin) 8x8 mm body (QFN) MM = Plastic Quad Flat, No Lead – (28-pin) 6x6 mm body (QFN-S) PT = Plastic Thin Quad Flatpack – (44-pin) 10x10 mm body (TQFP) PT = Plastic Thin Quad Flatpack – (64-pin) 10x10 mm body (TQFP) SO = Plastic Small Outline, Wide – (28-pin) 7.50 mm body (SOIC) Y8 = Thin Quad Flatpack – (48-pin) 7x7 mm (TQFP)

### Examples:

dsPIC33EP64GS504-I/PT:  
dsPIC33, Enhanced Performance,  
64-Kbyte Program Memory, SMPS,  
44-Pin, Industrial Temperature,  
TQFP Package.